

CR04AM-12

Thyristor

Low Power Use

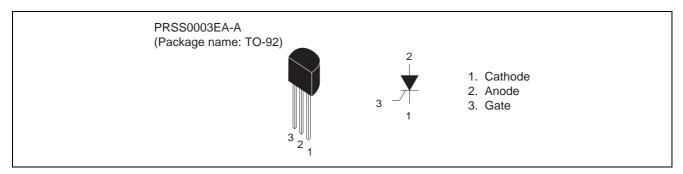
REJ03G0354-0200 Rev.2.00 Mar.01.2005

Features

 $\bullet \quad I_{T\,(AV)}:0.4\;A$

• Glass Passivation Type

Outline



Applications

Igniter, solid state relay, strobe flasher, circuit breaker, and other general purpose control applications

Maximum Ratings

Dorometer	Cumbal	Voltage class	Unit	
Parameter	Symbol	12		
Repetitive peak reverse voltage	V_{RRM}	600	V	
Non-repetitive peak reverse voltage	V_{RSM}	720	V	
DC reverse voltage	V _{R (DC)}	480	V	
Repetitive peak off-state voltage ^{Note1}	V_{DRM}	600	V	
DC off-state voltage ^{Note1}	V _{D (DC)}	480	V	

Parameter	Symbol	Ratings	Unit	Conditions
RMS on-state current	I _{T (RMS)}	0.63	Α	
Average on-state current	I _{T (AV)}	0.4	А	Commercial frequency, sine half wave 180° conduction, Ta = 54°C
Surge on-state current	I _{TSM}	10	А	60Hz sine half wave 1 full cycle, peak value, non-repetitive
I ² t for fusing	l ² t	0.4	A ² s	Value corresponding to 1 cycle of half wave 60Hz, surge on-state current
Peak gate power dissipation	P _{GM}	0.5	W	
Average gate power dissipation	P _{G (AV)}	0.1	W	
Peak gate forward voltage	V_{FGM}	6	V	
Peak gate reverse voltage	V_{RGM}	6	V	
Peak gate forward current	I _{FGM}	0.3	Α	
Junction temperature	Tj	- 40 to +125	°C	
Storage temperature	Tstg	- 40 to +125	°C	
Mass	_	0.23	g	Typical value

Notes: 1. With gate to cathode resistance $R_{GK} = 1 \text{ k}\Omega$.

Electrical Characteristics

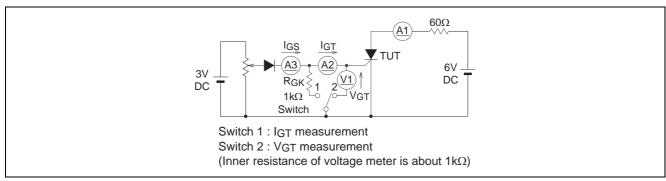
Parameter	Symbol	Min.	Тур.	Max.	Unit	Test conditions
Repetitive peak reverse current	I _{RRM}	_	_	0.5	mA	Tj = 125°C, V _{RRM} applied
Repetitive peak off-state current	I _{DRM}	_	_	0.5	mA	$Tj = 125$ °C, V_{DRM} applied, $R_{GK} = 1 \text{ k}\Omega$
On-state voltage	V_{TM}	_	_	1.2	V	Ta = 25°C, I _{TM} = 1.2 A, instantaneous value
Gate trigger voltage	V _{GT}	_	_	0.8	V	$Tj = 25$ °C, $V_D = 6$ V, $I_T = 0.1$ A ^{Note3}
Gate non-trigger voltage	V_{GD}	0.2	_	_	V	$Tj = 125^{\circ}C, V_D = 1/2 V_{DRM},$ $R_{GK} = 1 k\Omega$
Gate trigger current	I _{GT}	1	_	100 ^{Note2}	μΑ	$Tj = 25$ °C, $V_D = 6$ V, $I_T = 0.1$ A ^{Note3}
Holding current	I _H	_	1.5	3	mA	$Tj = 25$ °C, $V_D = 12$ V, $R_{GK} = 1$ k Ω
Thermal resistance	R _{th (j-a)}	_	_	150	°C/W	Junction to ambient

Notes: 2. If special values of I_{GT} are required, choose item D or E from those listed in the table below if possible.

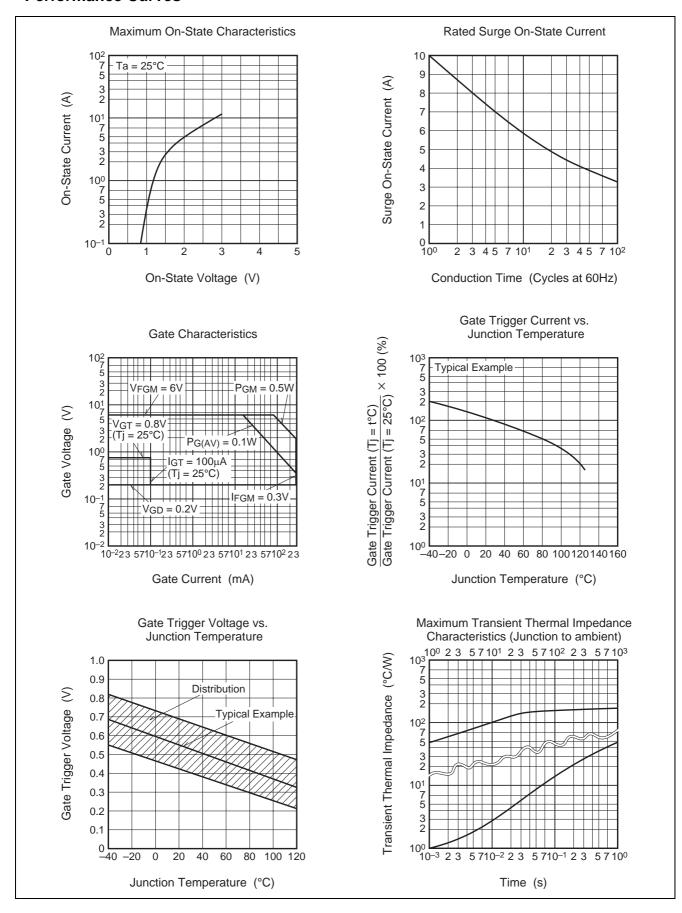
	Item	Α	В	С	D	E
Γ	I _{GT} (μA)	1 to 30	20 to 50	40 to 100	1 to 50	20 to 100

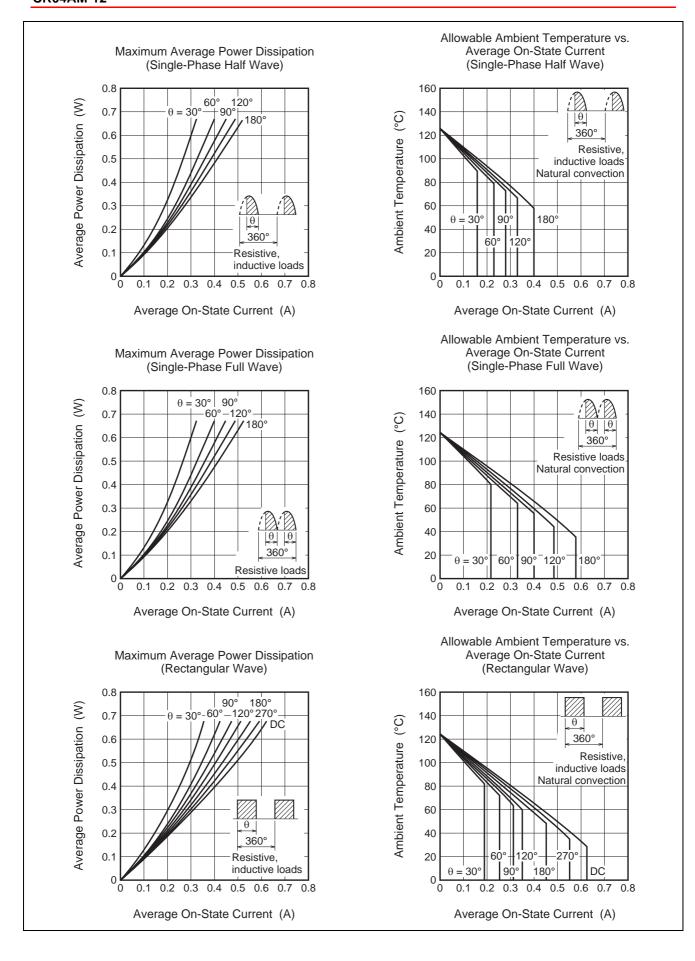
The above values do not include the current flowing through the 1 $k\Omega$ resistance between the gate and cathode.

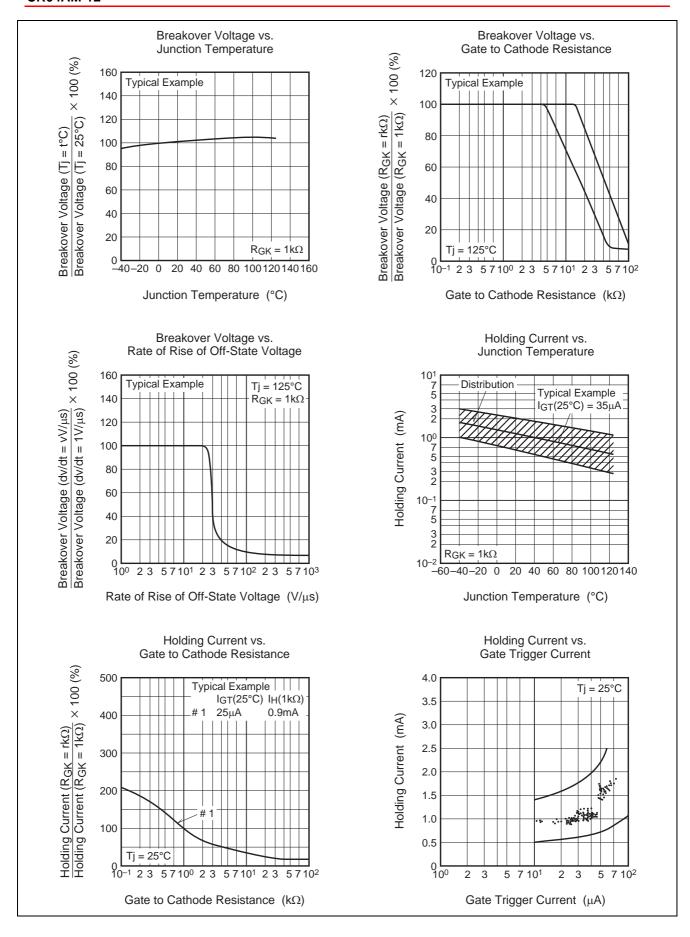
3. I_{GT} , V_{GT} measurement circuit.

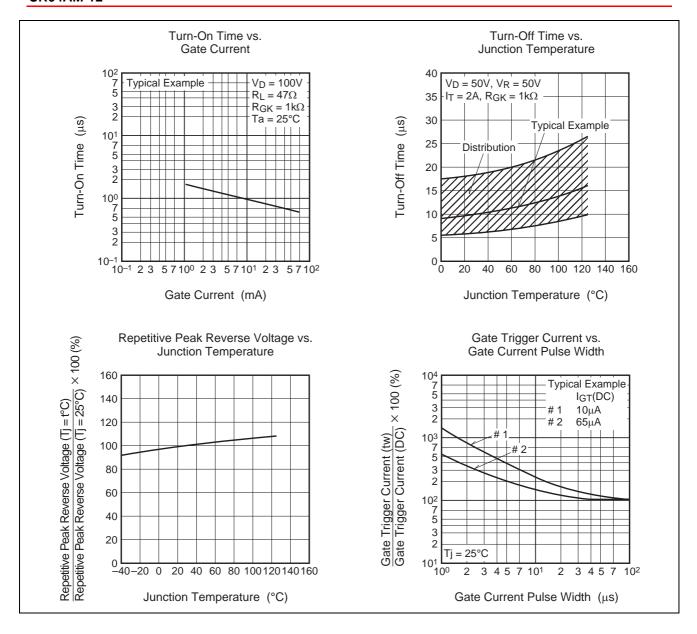


Performance Curves

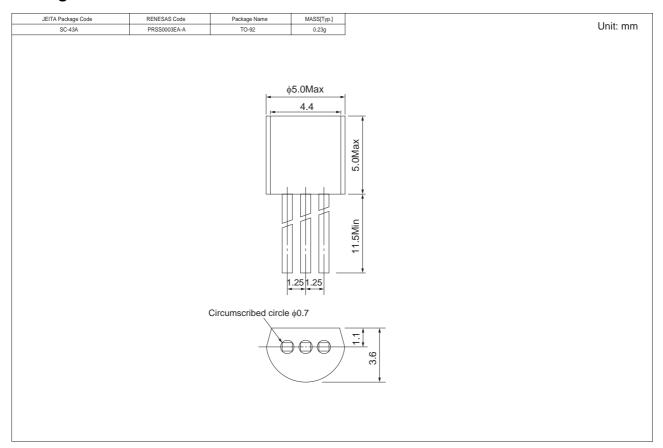








Package Dimensions



Order Code

Lead form	Standard packing	Quantity	Standard order code	Standard order code example
Straight type	Vinyl sack	500	Type name	CR04AM-12
Lead form	Vinyl sack	500	Type name – Lead forming code	CR04AM-12-A6
Form A8	Taping	2000	Type name – TB	CR04AM-12-TB

Note: Please confirm the specification about the shipping in detail.

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